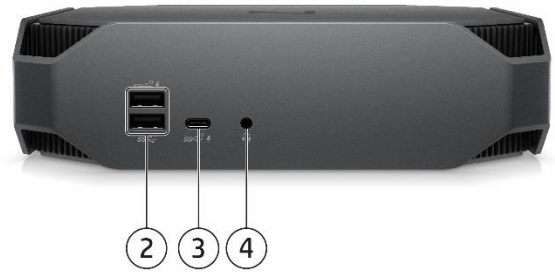


### Overview

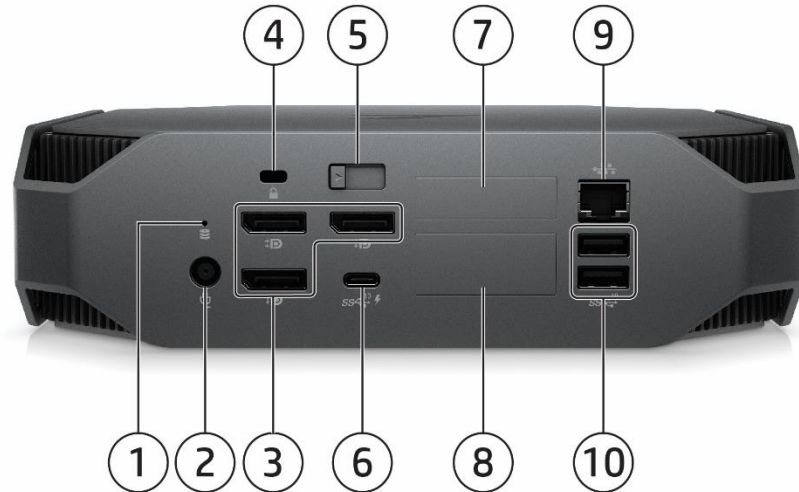
### HP Z2 Mini G5 Workstation



#### Front-Side View

1. Power button
2. 2 Type-A SuperSpeed USB 10Gbps signaling rate port (1 supports charging)
3. 1 Type-C® SuperSpeed USB 10Gbps signaling rate port (charging supported)
4. Universal audio jack

### Overview



#### Rear View

1. HDD Activity LED
2. Power connector
3. 1 DisplayPort™ (left down) <sup>4</sup>  
1 DisplayPort™ (left upper, optional) <sup>1,3,4</sup>  
1 DisplayPort™ (right upper, optional) <sup>1,2,4</sup>
4. Standard cable lock slot
5. Cover release latch
6. 1 Type-C® SuperSpeed USB 10Gbps signaling rate port (charging supported) (optional)²
7. Flex IO modules, choice of:  
Dual Type-A SuperSpeed USB 5Gbps signaling rate port, serial port<sup>1</sup>
8. Flex IO modules, choice of:  
VGA, HDMI 2.0b, DisplayPort™ 1.4<sup>4</sup>, Dual Type-A SuperSpeed USB 5Gbps signaling rate port, 2nd 1GbE LAN, Type-C® SuperSpeed USB 10Gbps signaling rate port (Alt Mode), Thunderbolt™ 3<sup>5</sup>, 2.5GbE LAN<sup>2</sup>
9. RJ-45
10. 2 Type-A SuperSpeed USB 10Gbps signaling rate port

<sup>1</sup>Available on selected configurations only.

<sup>2</sup>Entry Base Unit : Always not available ; Performance Base Unit : Only available when a discrete graphic card is installed on.

<sup>3</sup>Entry Base Unit : Always available; Performance Base Unit : Only available when a discrete graphic card is installed on.

<sup>4</sup>All DisplayPort™ support DP1.4/HBR2 when video output is via Intel Graphics.

<sup>5</sup>Thunderbolt 3 supported on Mini Performance version only.

#### Total DisplayPort

	Mini Entry	Mini Performance – no NVIDIA/AMD graphics	Mini Performance – NVIDIA/AMD graphics
DisplayPort™ Ports	2	1	3
Flex IO Port Display Port™ Port	1	1	1

### Overview

Total possible DisplayPort™ with Flex IO Port set as DisplayPort™	3	2	4
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### When DisplayPort are driven by different GPUs:

	Mini Entry	Mini Performance – no NVIDIA/AMD graphics	Mini Performance – NVIDIA/AMD graphics
DP#1	Intel Graphics	Intel Graphics	dGPU by default*
DP#2	Intel Graphics	N/A	dGPU
DP#3 (Flex IO for Entry)	Intel Graphics	N/A	dGPU
DP#4 (Flex IO for Performance)	N/A	Intel Graphics	dGPU by default*

\*DP#1/DP#4 of Mini Performance with NVIDIA/AMD graphics can be driven by discrete graphics (as default) or integrated Graphics, user can change the option in BIOS Advanced Settings (F10).  
 - Intel “F” series processors are without integrated graphics.

### Overview



**HP Z2 G5 Mini, bottom view**

Removable bottom feet for access to integrated VESA mounting holes

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### Overview

**Form Factor**

Mini

**Operating Systems**

Preinstalled:

- Windows 11 Pro<sup>2</sup>
- Windows 11 Pro for Workstations<sup>2</sup>
- Windows 11 Home - HP recommends Windows 11 Pro for business<sup>2</sup>
- Windows 10 Pro<sup>1,2</sup>
- Windows 10 Pro for Workstations<sup>1,2</sup>
- Windows 10 Home - HP recommends Windows 11 Pro for business<sup>1,2</sup>
- Ubuntu 20.04 LTS<sup>3</sup>
- Linux<sup>®</sup>-ready<sup>4</sup>
- Red Hat<sup>®</sup> Enterprise Linux<sup>®</sup> Desktop Workstation (Paper license with 1-year support; no preinstalled OS)

Web-Supported only:

- Windows 10 Enterprise 64<sup>2</sup>

Supported Version:

- HP tested Windows 10, version 1809 on this platform. For testing information on newer versions of Windows 10, please see: <https://support.hp.com/document/c05195282>.
- Red Hat<sup>®</sup> Enterprise Linux<sup>®</sup> Workstation 8
- SUSE Linux<sup>®</sup> Enterprise Desktop 15

<sup>1</sup> Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).

<sup>2</sup> Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>.

**NOTE:** Your product does not support Windows 8 or Windows 7. In accordance with Microsoft’s support policy, HP does not support the Windows<sup>®</sup> 8 or Windows 7 operating system on products configured with Intel<sup>®</sup> and AMD<sup>®</sup> 7th generation and forward processors or provide any Windows<sup>®</sup> 8 or Windows 7 drivers on <http://www.support.hp.com>. A full list of HP products and the Windows 10 versions tested is available on the HP support website. <https://support.hp.com/us-en/document/c05195282>

<sup>3</sup> Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply, and additional requirements may apply over time for updates.

<sup>4</sup> For detailed Linux<sup>®</sup> OS/hardware support information, see: [http://www.hp.com/support/linux\\_hardware\\_matrix](http://www.hp.com/support/linux_hardware_matrix)

**NOTE:** In accordance with Microsoft’s support policy, HP does not support the Windows<sup>®</sup> 7 operating system on products configured with Intel<sup>®</sup> 7th Generation and forward processors.

### Processors\*

Name	Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MT/s)	Hyper-Threading	Integrated Graphics	Intel <sup>®</sup> Turbo Boost Technology <sup>2</sup>	Featuring Intel <sup>®</sup> vPro <sup>™</sup> Technology <sup>3</sup>	16GB Intel <sup>®</sup> Optane <sup>™</sup> memory	TDP (W)
Intel <sup>®</sup> Core <sup>™</sup> i9-10900K Processor <sup>5</sup>	10	3.7	20	2933	Y	Intel <sup>®</sup> UHD Graphics 630	5.2	Y	Y	125

### Overview

Intel® Core™ i9-10900 Processor	10	2.8	20	2933	Y	Intel® UHD Graphics 630	5.1	Y	Y	65
Intel® Core™ i9-10900F Processor <sup>4</sup>	10	2.8	20	2933	Y	N/A	5.1	N/A	Y	65
Intel® Core™ i9-10850K Processor	10	3.6	20	2933	Y	Intel® UHD Graphics 630	5.2	N/A	Y	125
Intel® Core™ i7-10700K Processor <sup>5</sup>	8	3.8	16	2933	Y	Intel® UHD Graphics 630	5.1	Y	Y	125
Intel® Core™ i7-10700 processor	8	2.9	16	2933	Y	Intel® UHD Graphics 630	4.8	Y	Y	65
Intel® Core™ i5-10600K processor <sup>5</sup>	6	4.1	12	2666	Y	Intel® UHD Graphics 630	4.8	Y	Y	125
Intel® Core™ i5-10600 processor	6	3.3	12	2666	Y	Intel® UHD Graphics 630	4.8	Y	Y	65
Intel® Core™ i5-10500 processor	6	3.1	12	2666	Y	Intel® UHD Graphics 630	4.5	Y	Y	65
Intel® Core™ i5-10400 processor	6	2.9	12	2666	Y	Intel® UHD Graphics 630	4.3	N/A	Y	65
Intel® Core™ i5-10400F Processor <sup>4</sup>	6	2.9	12	2666	Y	N/A	4.3	N/A	Y	65
Intel® Core™ i3-10320 processor <sup>4</sup>	4	3.8	8	2666	Y	Intel® UHD Graphics 630	4.6	N/A	Y	65
Intel® Core™ i3-10300 processor <sup>4</sup>	4	3.7	8	2666	Y	Intel® UHD Graphics 630	4.4	N/A	Y	65
Intel® Core™ i3-10100 processor	4	3.60	6	2666	Y	Intel® UHD Graphics 630	4.3	N/A	Y	65
Intel® Xeon® W-1290P processor <sup>5</sup>	10	3.7	20	2933	Y	Intel® UHD Graphics P630	5.2	Y	Y	125
Intel® Xeon® W-1290 processor <sup>4</sup>	10	3.2	20	2933	Y	Intel® UHD Graphics P630	5.1	Y	Y	80
Intel® Xeon® W-1270P processor <sup>4,5</sup>	8	3.8	16	2933	Y	Intel® UHD Graphics P630	5.1	Y	Y	125
Intel® Xeon® W-1270 processor	8	3.4	16	2933	Y	Intel® UHD Graphics P630	5.0	Y	Y	80
Intel® Xeon® W-1250P processor <sup>5</sup>	6	4.1	12	2666	Y	Intel® UHD Graphics P630	4.8	Y	Y	125
Intel® Xeon® W-1250 processor	6	3.3	12	2666	Y	Intel® UHD Graphics P630	4.7	Y	Y	80

### Overview

<sup>1</sup>Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

<sup>2</sup>The specifications shown in the Intel® Turbo Boost Technology column represent the maximum turbo frequency with one core active. Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See <http://www.intel.com/technology/turboboost> for more information.

<sup>3</sup> For full Intel® vPro™ functionality, Windows, a vPro™ supported processor, vPro™ enabled Q370 chipset or higher and vPro™ enabled WLAN card are required. Some functionality, such as Intel Active management technology and Intel Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Intel vPro™ technology is dependent on 3rd party software providers. Compatibility of this generation of Intel vPro™ technology-based hardware with future "virtual appliances" is yet to be determined.

<sup>4</sup>Available in Q4, 2020

<sup>5</sup>Configurable TDP-down 95W

**Convertibility** Z2 Mini G5 can either be placed on a flat surface or mounted behind a display or under a desk. (Mounting sold separately)

**Expansion Slots** 1 MXM slot (PCIe Gen3 x16) – for discrete graphic card only  
 (see system board section for more details) 2 80mm M.2 Storage slot (PCIe Gen3 x4)  
 1 30mm M.2 WLAN slot (PCIe Gen3 x1 / Intel CNVI) – for WLAN/BT M.2 modules only

**NOTE:** The PCIe Gen3 x16 slot is meant for HP qualified cards, configured or after market. HP does not provide warranty support for 3rd party cards.

### Front I/O

**Side I/O** 2 Type-A SuperSpeed USB 10Gbps signaling rate port (upper port supports charging), 1 Type-C® SuperSpeed USB 10Gbps signaling rate port (charging supported), 1 Universal audio combo

**Rear I/O** 2 DisplayPort™ 1.4<sup>1</sup>, 1 RJ-45 port, 2 Type-A SuperSpeed USB 10Gbps signaling rate port

Optional: 1 Type-C® SuperSpeed USB 10Gbps signaling rate port (optional, supports charging), 1 DisplayPort™ 1.4<sup>1</sup>, 2 Flex IO modules\*

\*Thunderbolt 3 supported on Mini Performance version only.

**On-board RAID Support** NVMe RAID 0 Striped Array  
 NVMe RAID 1 Mirrored Array

**Chassis Dimensions (H x W x D)** H: 2.28" [58mm] (Standard desktop orientation)  
 W: 8.5" [216mm]  
 D: 8.5" [216mm]

**Packaged Dimensions** H: 11.73" (298mm)  
 W: 6.69" (170mm)  
 D: 19.65" (499mm)

**Rack Dimensions** 5U

**Weight** Exact weights depend upon configuration  
 Minimum: 2.1kg (4.6lbs.)  
 Maximum: 2.42kg (5.3lbs.)

### Overview

<b>Temperature</b>	Operating: 5° to 35° C (40° to 95° F) Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation Non-operating: -40° to 60° C (-40° to 140° F) Maximum rate of change: 10°C/hr
<b>Humidity</b>	Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb
<b>Maximum Altitude (non-pressurized)</b>	Operating (with Rotational Hard Drives): 3,048 m (10,000 feet) Operating (with only Solid-State Drives): 5,000 m (16,404 feet) Non-operating: 12,192 m (40,000 feet) Maximum operating temperature is reduced as altitude increases. See Temperature for details.
<b>Power Supply</b>	Choice of: 180W 89% Average Efficiency. 280W 89% Average Efficiency. <b>NOTES:</b> Customers placing their system in an enclosure should design their solution to accommodate the size of the external power supply for the Z2 Mini G5
<b>Workstation ISV Certifications</b>	See the latest list of certifications at <a href="http://www.hp.com/united-states/campaigns/workstations/partnerships.html">http://www.hp.com/united-states/campaigns/workstations/partnerships.html</a>
<b>Chipset</b>	Intel® W480 chipset
<b>Memory</b>	2 SODIMM slots, supporting up to 64GB ECC/non-ECC, DDR4 2933 MT/s, speed depending on the CPU selection.

<sup>1</sup>All DisplayPort™ support DP1.4/HBR2 when video output is via Intel Graphics. Discrete graphics support DP1.4 / HBR3.



### Supported Components

Processors	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
<b>10th Generation Intel Core Processors<sup>1</sup></b>				
Intel® Core™ i9 10900K Processor	Y	N		3
Intel® Core™ i9 10900 Processor	Y	N		
Intel® Core™ i9 10900F Processor	Y	N		1
Intel® Core™ i9 10850K Processor	Y	N		
Intel® Core™ i7 10700K Processor	Y	N		3
Intel® Core™ i7 10700 processor	Y	N		
Intel® Core™ i5 10600K processor	Y	N		3
Intel® Core™ i5 10600 processor	Y	N		
Intel® Core™ i5 10500 processor	Y	N		
Intel® Core™ i5 10400 processor	Y	N		
Intel® Core™ i9 10400F Processor	Y	N		1
Intel® Core™ i3 10320 processor	Y	N		2
Intel® Core™ i3 10300 processor	Y	N		2
Intel® Core™ i3 10100 processor	Y	N		
<b>Intel Xeon W Processors</b>				
Intel® Xeon® W-1290P processor	Y	N		3
Intel® Xeon® W-1290 processor	Y	N		2
Intel® Xeon® W-1270P processor	Y	N		2,3
Intel® Xeon® W-1270 processor	Y	N		
Intel® Xeon® W-1250P processor	Y	N		3
Intel® Xeon® W-1250 processor	Y	N		

<sup>1</sup>These processors support only non-ECC memory

**NOTE 1:** No integrated graphics. A discrete graphics card must be purchased at the same time. Available in Q4, 2020

**NOTE 2:** Available in Q4, 2020

**NOTE 3:** TDP configured down to 95W.

Storage / Hard Drives*	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
<b>SATA Hard Drives</b>				
500GB SATA 7200 rpm 6Gb/s SFF HDD (2.5")	Y	Y	T0K73AA	4
1TB SATA 7200 rpm 6Gb/s SFF HDD (2.5")	Y	Y	T0K74AA/AT	4
2 TB SATA 5400 rpm SFF HDD (2.5")	Y	N		
500GB SATA 7.2K SED SFF HDD	Y	Y	D8N29AA	4
Z2 G5 Mini HDD Carrier Cage	Y	Y	1X5Q2AA/AT	
<b>SATA Solid State Drives</b>				
HP 256GB SATA 6Gb/s SSD	Y	Y	A3D26AA/AT	4
HP 2TB SATA SSD			Y6P08AA/AT	4
<b>PCIe Solid State Drives</b>				
HP ZTurbo 1TB TLC Z2 G5 Mini SSD Kit	Y	Y	141L4AA/AT	
HP ZTurbo 256GB SED Z2 G5 Mini SSD Kit	Y	Y	141L6AA/AT	

### Supported Components

HP ZTurbo 256GB TLC Z2 G5 Mini SSD Kit	Y	Y	141L9AA/AT
HP ZTurbo 2TB TLC Z2 G5 Mini SSD Kit	Y	Y	141M0AA/AT
HP ZTurbo 512GB SED Z2 G5 Mini SSD Kit	Y	Y	141M2AA/AT
HP ZTurbo 512GB TLC Z2 G5 Mini SSD Kit	Y	Y	141M4AA/AT
HP 2TB PCIe NVME TLC M.2 Z2 G5 Mini SSD	Y	Y	35F75AA

**NOTE1:** SATA hardware-assisted RAID is not supported on Linux® systems. The Linux® kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-assisted RAID. All drives must be identical in type and capacity. Boot volume/RAID array must be less than 2 TB

**NOTE2:** 125W CPU SKU is not supported to install the SATA 2.5in HDD or SSD.

**NOTE3:** 65W CPU and MXM GFX card SKU is not supported to install the SATA 2.5in HDD or SSD.

**NOTE4:** Only compatible with 65W CPU

\*For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

### Graphics

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
<b>Graphics Cable Adapters</b>				
HP DisplayPort To HDMI True 4k Adapter	Y	Y	2JA63AA	
HP DisplayPort To DVI-D Adapter	Y	Y	FH973AA	
HP DisplayPort To VGA Adapter	Y	Y	AS615AA	
HP USB-C to DisplayPort Adapter	Y	Y	4SH08AA	
HP USB-C to HDMI Adapter	Y	Y	4SH07AA	
HP USB-C to VGA Adapter	Y	Y	4SH06AA	
<b>Entry 3D</b>				
AMD Radeon™ Pro WX 3200 4GB MXM Graphics	Y	N		
NVIDIA® Quadro® P620 4GB MXM Graphics	Y	N		1
<b>Mid-range 3D</b>				
NVIDIA® Quadro® T1000 4GB MXM Graphics	Y			
NVIDIA® Quadro® T2000 4GB MXM Graphics	Y			
NVIDIA® Quadro® RTX 3000 6GB MXM Graphics	Y	N		2
<b>NOTE 1:</b> Available in Q4, 2020				
<b>NOTE 2:</b> Available in Q1, 2021				

### Memory

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP 4GB (1x4GB) DDR4-3200 nECC SO DIMM	Y			
HP 8GB (2x4GB) DDR4-3200 nECC SO DIMM	Y			
HP 8GB (1x8GB) DDR4-3200 nECC SO DIMM	Y			
HP 8GB (1x8GB) DDR4-3200 ECC SO DIMM	Y			
HP 16GB (2x8GB) DDR4-3200 nECC SO DIMM	Y			
HP 16GB (2x8GB) DDR4-3200 ECC SO DIMM	Y			
HP 16GB (1x16GB) DDR4-3200 nECC SO DIMM	Y			

### Supported Components

HP 16GB (1x16GB) DDR4-3200 ECC SO DIMM	Y
HP 32GB (2x16GB) DDR4-3200 nECC SO DIMM	Y
HP 32GB (2x16GB) DDR4-3200 ECC SO DIMM	Y
HP 32GB (1x32GB) DDR4-3200 nECC SO DIMM	Y
HP 32GB (1x32GB) DDR4-3200 ECC SO DIMM	Y
HP 64GB (2x32GB) DDR4-3200 nECC SO DIMM	Y
HP 64GB (2x32GB) DDR4-3200 ECC SO DIMM	Y

#### AMO

HP 4GB (1x4GB) DDR4-3200 nECC SO DIMM	N	141J0AA/AT
HP 8GB (1x8GB) DDR4-3200 nECC SO DIMM	N	141J5AA/AT
HP 8GB (1x8GB) DDR4-3200 ECC SO DIMM	N	141J2AA/AT
HP 16GB (1x16GB) DDR4-3200 nECC SO DIMM	N	141H5AA/AT
HP 16GB (1x16GB) DDR4-3200 ECC SO DIMM	N	141H4AA/AT
HP 32GB (1x32GB) DDR4-3200 nECC SO DIMM	N	141H8AA/AT
HP 32GB (1x32GB) DDR4-3200 ECC SO DIMM	N	141H6AA/AT

**NOTES:** The CPUs determine the speed at which the memory is clocked. If a 2666 MHz capable CPU is used in the system, the maximum speed the memory will run at is 2666 MHz regardless of the specified speed of the memory.

Intel® Xeon® W processors can support either ECC or non-ECC memory; Intel® Core™ i3/i5/i7 processors only support non-ECC memory.

Two channels of DDR4 memory are supported. To realize full performance at least one DIMM must be inserted into each channel.

### Optical and Removable Storage

	Factory Configured	Option Kit	Option Kit Part Number
<b>HP Slim Tray Optical Drives</b>			
HP External Ultra-Slim DVD-RW Drive	N	Y	Y3T76AA

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

### Networking and Communications

	Factory Configured	Option Kit	Option Kit Part Number
Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro™ with Intel AMT 12.0)	Y	N	
Intel Wi-Fi 6 AX201 (2x2) and Bluetooth 5 combo	Y	N	
HP 1GbE LAN Flex Port 2020	Y	Y	141J6AA/AT
HP 2.5GbE LAN Flex Port Z2 Mini	Y	Y	169K0AA/AT
HP Flex 1GbE Fiber LC Single Port	Y	Y	20J15AA

**NOTE 1:** The integrated network connection is required to support Intel® vPro™ Technology.

**NOTE 2:** If AMT is provisioned, then network teaming with the integrated LAN port is not possible.

**NOTE 3:** "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and

### Supported Components

does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Racking and Physical Security	Factory Configured	Option Kit	Option Kit Part Number
HP Keyed Cable Lock 10mm	N	Y	T1A62AA
Z2 Mini ePSU rack mount bracket Kit	N	Y	3RW67AA
HP Z2 Mini Vertical Stand	N	Y	3RW66AA
HP Z2 Mini VESA Sleeve	N	Y	Y7B61AA
HP Business PC Security Lock v3 Kit	N	Y	3XJ17AA
HP Z2 Mini Rack Tray Support Kit	N	Y	1A4W4AA
HP Z2 Mini and TWR/Z4/Z6 G4 Depth Adjustable Fixed Rail Rack Kit	N	Y	2HW42AA/AT
HP Z2 Mini/Z2 Tower/Z4/Z6 Depth Adjustable Fixed Rail Rack Kit	N	Y	2A8Y5AA
Z2 G5 Mini HDD Carrier Cage	Y	Y	1X5Q2AA/AT
HP B300 PC Mounting Bracket	N	Y	2DW53AA
HP B500 PC Mounting Bracket	N	Y	2DW52AA
HP B550 Z Display PC Mounting Bracket	N	Y	16U00AA

Input Devices	Factory Configured	Option Kit	Option Kit Part Number
HP Premium Wireless Keyboard	Y	Y	Z9N41AA/AT
HP USB 320K Keyboard	Y	Y	9SR37AA
HP USB Business Slim Wired Smartcard CCID Keyboard	Y	N	
HP Wireless Business Slim Keyboard and Mouse	Y	Y	
HP USB Premium Wired Keyboard	Y	Y	Z9N40AT
HP 320M Wired Mouse	Y	Y	9VA80AA
HP USB Premium Mouse	Y	Y	1JR32AA
HP Wireless Premium Mouse	Y	Y	1JR31AA
HP Wired Desktop 320MK Mouse and Keyboard	N	Y	9SR36AA
HP Creator 935 Black Wireless Mouse	N	Y	1D0K8AA

Other Hardware	Factory Configured	Option Kit	Option Kit Part Number
HP Z2 Power Cord Kit	Y	Y	1N1D5AA
HP 280W Slim Smart 7.4mm AC Adapter	Y	Y	4J0P0AA
HP DP Flex Port 2020	Y	Y	141J7AA/AT
HP Dual USB-A 3.2 Gen1 Flex Port 2020	Y	Y	141J8AA/AT
HP Dual USB-A 3.2 Gen1 Flex Port 2020 Mini	Y	Y	141J9AA/AT
HP USB-C® 3.2 Gen2 Alt Flex Port 2020	Y	Y	141K6AA/AT
HP HDMI Flex Port 2020	Y	Y	141K1AA/AT
HP VGA Flex Port 2020	Y	Y	141K7AA/AT

### Supported Components

HP Mini Serial Upper Flex Port 2020 Mini	Y	Y	141K2AA/AT
HP Thunderbolt™ 3 Flex Port 2020 Mini*	Y	Y	141K4AA/AT

\*Supported on Mini Performance version only.

### Software

	Factory Configured	Option Kit	Support Notes
HP Performance Advisor	Y	N	1
HP PC Hardware Diagnostics UEFI (Windows OS only)	Y	N	2
HP PC Hardware Diagnostics Windows	Y	N	
HP Sure Sense	Y	N	
HP Notifications	Y	N	
HP Desktop Support Utility	Y	N	
HP Documentation	Y	N	
HP Image Assistant	N	N	
HP Support Assistant	N	N	

**NOTE 1:** Supports and preinstalled with Windows 10 and Windows 11 only. Also available as a free download from <http://www.hp.com/go/performanceadvisor>

**NOTE 2:** Windows OS only

### Application Software

	Factory Configured	Option Kit	Support Notes
Sobey Video Editing SW	Y	N	China only
HP ZCentral Remote Boost	N	N	
Data Science Stack	Y	N	1,2
WSL2/Ubuntu Data Science Stack	Y	N	1,3

\*Not all Application Software for Z Desktop Workstations is included with purchase.

**Note 1:** Only available with NVIDIA graphics cards selections.

**Note 2:** Only available with Ubuntu 20.04 LTS preinstall.

**Note 3:** Only available with Windows 10 Pro/Pro for Workstations or Windows 11 Pro/Pro for Workstations.

### Operating Systems

- Windows 11 Pro<sup>2</sup>
- Windows 11 Pro for Workstations<sup>2</sup>
- Windows 11 Home - HP recommends Windows 11 Pro for business<sup>2</sup>
- Windows 10 Pro<sup>1,2</sup>
- Windows 10 Pro for Workstations<sup>1,2</sup>
- Windows 10 Home - HP recommends Windows 11 Pro for business<sup>1,2</sup>
- Ubuntu 20.04 LTS
- Linux-Ready
- Red Hat Enterprise Linux(RHEL) Workstation – Paper license (1 yr)

**NOTE 1:** Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).

### Supported Components

**NOTE 2:** Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>.

**NOTE:** Windows 11 Pro/Pro for Workstations and Windows 10 Pro/Pro for Workstations is available with Windows Subsystem for Linux® (WSL 2).

**NOTE:** For detailed QS/hardware support information for Linux, see: [http://www.hp.com/support/linux\\_hardware\\_matrix](http://www.hp.com/support/linux_hardware_matrix)

### HP BIOS

Key features of the HP BIOS include:

- Deployment and manageability – HP BIOS provides several technologies that help integrate the HP Z2 G5 Workstation into the enterprise, such as PXE, remote recovery, remote configuration, remote control, and BIOS (F10) Setup support for 15 languages.
- Network firmware updates – Update your BIOS via the cloud or standardize on a BIOS version hosted on an Enterprise network.
- Stability – HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- Class 3 UEFI specification version 2.7
- Absolute Persistence agent – For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management – The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Workstation computer in any enterprise environment.
- Acoustic performance – Industry leading acoustic emissions across the range of operating conditions.
- Serviceability – HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery – HP BIOS provides numerous ways to upgrade HP Workstation computers, including BIOS updates from within Windows (HP Firmware Update and Recovery), HP Client Manager, and fail-safe recovery. In addition, the HP BIOS Configuration Utility enables replication of BIOS settings within Windows while the Replicated Setup feature provides the same capability within BIOS (F10) Setup. The BIOS Configuration Utility is available from the HP support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS Features:

- Power-On password – Helps prevent an unauthorized user from powering on the system.
- Administrator password – Also known as the BIOS Setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS cannot be updated and changes cannot be made to BIOS settings using BIOS Setup or under the OS.
- S4/S5 Maximum Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 0.5W in S4/S5 (when turned off). When S4/S5 Maximum Power Savings feature is enabled below features are turned off:
  - -Power to expansion connectors / slots
  - -Wake events other than power buttons (such as wake on LAN)
  - -USB charging ports

### Supported Components

#### HP Sure Start Gen6 Start

- BIOS Integrity checking – Sure Start protection ensures that only trusted BIOS code is executed and not rootkits, viruses and malware. Verification is done upon boot up, shutdown and while the system is on.
- Sure Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability. Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability.
- Protecting beyond BIOS – Integrity checking and repair is extended to other data that should be protected such as network configuration parameters, platform specific information (i.e. system IDs), secure boot credentials, and other code the system needs to boot.
- Audit enabled – System Audit via Sure Start Event Logs capture data such as incident, repair date and time for troubleshooting and investigating.

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## SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

### BIOS

HP BIOSphere Gen6<sup>10</sup>

BIOS Update via Network

HP Secure Erase<sup>11</sup>

Absolute Persistence Module<sup>12</sup>

Pre-boot Authentication

HP Wake on WLAN

HP DriveLock & Automatic DriveLock

### Software

HP Support Assistant<sup>13</sup>

HP Desktop Support Utilities

HP Notifications

HP PC Hardware Diagnostics UEFI

HP PC Hardware Diagnostics Windows

HP Performance Advisor<sup>14</sup>

HP ZCentral Remote Boost<sup>15</sup>

HP Setup Integrated OOBE

HSA Fusion for Commercial

HSA Telemetry for Commercial

Buy Office (sold separately)

### Manageability Features

HP Driver Packs (download)<sup>16</sup>

HP System Software Manager (SSM) (download)

HP BIOS Config Utility (BCU) (download)

HP Manageability Integration Kit Gen4 (download)<sup>17</sup>

HP Image Assistant Gen5 (download)

HP Client Catalog (download)

HP Client Management Script Library (download)

HP Smart Support<sup>25</sup>

### Client Security Software

HP Client Security Manager Gen6<sup>18</sup>

### Supported Components

HP Security Manager (including Credential Manager, HP Password Manager, HP Spare Key)  
HP Sure Run Gen3<sup>22</sup>  
HP Power On Authentication  
Windows Defender<sup>19</sup>

#### Security Management

HP Sure Click<sup>20</sup>  
HP Sure Start Gen6<sup>21</sup>  
HP Sure Sense<sup>23</sup>  
HP Sure Recover Gen3<sup>24</sup>

10. HP BIOSphere Gen6 features may vary depending on configuration.

11. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

12. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit:

<https://www.absolute.com/about/legal/agreements/absolute/>

13. HP Support Assistant requires Windows and internet access

14. HP Performance Advisor Software - HP Performance Advisor is ready and waiting to help you get the most out of your HP Workstation from day one—and every day after. Learn more or download at:

<https://www8.hp.com/us/en/workstations/performance-advisor.html>

15. HP ZCentral Remote Boost Sender does not come preinstalled on Z Workstations but can be downloaded and run on all Z desktop and laptops without license purchase through 2022. With non-Z sender devices, purchase of perpetual individual license or perpetual floating license per simultaneously executing versions and purchase of ZCentral Remote Boost Software Support is required. ZCentral Remote Boost Sender for non-Z Hardware requires a license and Windows 10, RHEL/CentOS (7 or 8), or UBUNTU 18.04 or 20.04 LTS operating systems. macOS (10.14 or newer) operating system and ThinPro 7.2 are only supported on the receiver side. Requires network access. The software is available for download at [hp.com/ZCentralRemoteBoost](http://hp.com/ZCentralRemoteBoost).

16. HP Driver Packs not preinstalled, however available for download at <http://www.hp.com/go/clientmanagement>

17. HP Manageability Integration Kit can be downloaded from

<http://www8.hp.com/us/en/ads/clientmanagement/overview.html>

18. HP Client Security Manager Gen6 requires Windows and is available on select HP Pro and Elite PCs

19. Windows Defender Opt in and internet connection required for updates.

20. HP Sure Click requires Windows Pro or Enterprise. See [https://bit.ly/2PrLT6A\\_SureClick](https://bit.ly/2PrLT6A_SureClick) for complete details

21. HP Sure Start Gen6 is available on select HP PCs.

22. HP Sure Run Gen3 is available on select Windows based HP Pro, Elite and Workstation PCs with select Intel® or AMD processors.

23. HP Sure Sense requires Windows

24. HP Sure Recover Gen3 HP Sure Recover Gen3 is available on select HP PCs and requires an open network connection. Not available on platforms with multiple internal storage drives. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. Network based recovery using Wi-Fi is only available on PC's with Intel Wi-Fi Module.

25. HP Smart Support is available to commercial customers through your HP Service Representative and HP Factory Configuration Services; or it can be downloaded at: <http://www.hp.com/smart-support>. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights.



### System Technical Specifications

#### System Board

**System Board Form Factor** 202.2 x 198.5 mm (7.96 x 7.815 inch)

<b>Processor Socket</b>	Single LGA-1200
<b>CPU Bus Speed</b>	DMI
<b>Chipset</b>	Intel® PCH W480
<b>Super I/O Controller</b>	Nuvoton SIO18
<b>Memory Expansion Slots</b>	2 DDR4 memory slots
<b>Memory Type Supported</b>	DDR4, SODIMM ECC & non-ECC
<b>Memory Modes</b>	Non-Interleaved for single channel. Interleaved when both channels are populated.
<b>Memory Speed Supported</b>	2933MT/s DDR4
<b>Memory Protection</b>	ECC available on data
<b>Maximum Memory</b>	64GB
<b>Memory Configuration (Supported)</b>	4GB, 8GB 16GB and 32GB non-ECC and 8GB, 16GB and 32GB ECC SO DIMMs are supported. ECC and non-ECC memory DIMMs cannot be mixed in the same system
<b>PCI Express Connectors</b>	<ul style="list-style-type: none"> <li>• 1 MXM PCI Express Gen3 slot x16</li> <li>• 2 M.2 Storage (PCIe Gen3 x4)</li> <li>• 1 M.2 WLAN (PCIe Gen3 x1+ Intel CNVi)</li> </ul>
<b>Supported Drive Interfaces</b>	<p><b>SATA</b> Integrated (1) Serial ATA interfaces (6Gb/s SATA).</p> <p><b>Network Controller</b> Integrated Ethernet PHY Connection I219LM. Management capabilities: WOL, PXE 2.1 and AMT 12</p> <p><b>Serial</b> 1 rear port (requires optional Serial Port Adapter Kit)</p> <p><b>HD Integrated Audio</b> Yes</p>
<b>USB Connector(s)</b>	<p><b>Front</b> 2 Type-A SuperSpeed USB 10Gbps signaling rate port (1 charge supports up to 5V/2.1A); 1 Type-C® SuperSpeed USB 10Gbps signaling rate port (charge supports up to 5V/3A)</p> <p><b>Rear</b> 2 Type-A SuperSpeed USB 10Gbps signaling rate port; 1 Type-C® SuperSpeed USB 10Gbps signaling rate port (optional); 1 Type-C® SuperSpeed USB 10Gbps signaling rate Alt mode port (optional via Flex)</p> <p><b>Internal</b> 2 Type-A SuperSpeed USB 5Gbps signaling rate port</p>
<b>HD Integrated Audio</b>	Yes
<b>Flash ROM</b>	Yes
<b>CPU Fan Header</b>	Yes
<b>Memory Fan Header</b>	None
<b>Chassis Fan Header</b>	None
<b>Front PCI Fan Header</b>	1 GPU Fan (most)
<b>Front Control Panel/Speaker Header</b>	Yes

### System Technical Specifications

<b>CMOS Battery Holder - Lithium</b>	Yes
<b>Integrated Trusted Platform Module</b>	Integrated TPM 2.0 Convertible to FIPS 140-2 Certified mode through firmware v7.85 The TPM module disabled where restricted by law, i.e. Russia.
<b>Power Supply Headers</b>	DC Jack for adapter
<b>Power Switch, Power LED &amp; Hard Drive LED Header</b>	Yes
<b>Clear Password Jumper</b>	None
<b>Keyboard/Mouse</b>	USB
<b>Operating Voltage Range</b>	90–269 VAC
<b>Rated Voltage Range</b>	100–240 VAC
<b>Rated Line Frequency</b>	50–60 Hz
<b>Operating Line Frequency Range</b>	47–66 Hz
<b>Rated Input Current</b>	6A@100–240V
<b>Heat Dissipation</b>	Typical: 444 btu/hr (112 kcal/hr) Maximum: 1484 btu/hr (374 kcal/hr)
<b>ENERGY STAR® certified (Config Dependent)</b>	Yes
<b>CECP Compliant @ 220V</b>	Yes
<b>FEMP Standby Power Compliant</b>	Yes, with Wake-on-LAN disabled: <2W in S5- Power Off
<b>Built-in Self Test (BIST) LED</b>	No
<b>Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)</b>	Yes

### System Configurations

<b>Z2 Mini G5 Configuration #1</b>	<b>Processor Info</b>	CPU I Core i5-10400 2.9GHz 6C65W
	<b>Memory Info</b>	8GB (1x 8GB) 2666 MHz DDR4 non-ECC
<b>ENERGY STAR CERTIFIED</b>	<b>Graphics Info</b>	Intel® UHD Integrated Graphics 630
	<b>Disks/Optical/Floppy</b>	1x SATA 1TB 7.2k rpm
	<b>Power Supply</b>	180W

Energy Consumption (Watts)	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows long Idle (S0)	7.38		8.76		7.03	

### System Technical Specifications

Windows short Idle (S0)	10.74		12.02		9.96	
Windows Busy Typ (S0)	90.37		99.52		88.23	
Windows Busy Max (S0)	95.11		102.78		93.86	
Sleep (S3)	0.78	0.45	0.82	0.51	0.73	0.41
Off (S5)	0.59	0.57	0.61	0.59	0.57	0.56
Zero Power Mode (ErP)	0.21		0.22		0.2	

### Heat Dissipation (Btu/hr)

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
Windows long Idle (S0)	25.181		29.889		23.986	
Windows short Idle (S0)	36.645		41.012		33.984	
Windows Busy Typ (S0)	308.342		339.562		301.041	
Windows Busy Max (S0)	324.515		350.685		320.25	
Sleep (S3)	2.661	1.535	2.798	1.74	2.491	1.399
Off (S5)	2.013	1.945	2.081	2.013	1.945	1.911
Zero Power Mode (ErP)	0.717		0.751		0.682	

### Z2 Mini G5 Configuration #2

Processor Info	CPU I Core i7-10700 2.9GHz 8C65W
Memory Info	16GB (2x 8GB) 2666 MHz DDR4 non-ECC
Graphics Info	T1000 Graphics
Disks/Optical/Floppy	1x SATA 256GB SSD
Power Supply	280W

### Energy Consumption (Watts)

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows long Idle (S0)	15.23		15.63		15.01	
Windows short Idle (S0)	18.35		18.82		17.98	
Windows Busy Typ (S0)	109.47		109.88		107.36	
Windows Busy Max (S0)	140.9		142.95		138.56	
Sleep (S3)	1.13	0.73	1.15	0.78	1.1	0.69
Off (S5)	0.62	0.61	0.63	0.61	0.61	0.6
Zero Power Mode (ErP)	0.21		0.23		0.2	

### Heat Dissipation (Btu/hr)

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
Windows long Idle (S0)	51.965		53.33		51.214	
Windows short Idle (S0)	62.61		64.214		61.348	
Windows Busy Typ (S0)	373.512		374.911		366.312	
Windows Busy Max (S0)	480.751		487.745		472.767	
Sleep (S3)	3.856	2.491	3.924	2.661	3.753	2.354
Off (S5)	2.115	2.081	2.15	2.081	2.081	2.047
Zero Power Mode (ErP)	0.717		0.785		0.682	

### Z2 Mini G5 Configuration #3

Processor Info	CPU I Core i9-10900K 3.7GHz 10C125W
Memory Info	64GB (2x 32GB) 2666 MHz DDR4 ECC
Graphics Info	T1000 Graphics
Disks/Optical/Floppy	1x SATA 512GB SSD
Power Supply	280W

### ENERGY STAR CERTIFIED



### System Technical Specifications

#### Energy Consumption (Watts)

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows long Idle (S0)	15.31		16.52		15.06	
Windows short Idle (S0)	18.74		19.04		18.32	
Windows Busy Typ (S0)	152.66		153.69		150.02	
Windows Busy Max (S0)	191.14		197.91		189.96	
Sleep (S3)	1.94	1.5	2.07	1.64	1.91	1.45
Off (S5)	0.62	0.6	0.63	0.61	0.61	0.6
Zero Power Mode (ErP)	0.23		0.24		0.22	

#### Heat Dissipation (Btu/hr)

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
Windows long Idle (S0)	52.238		56.366		51.385	
Windows short Idle (S0)	63.941		64.964		62.508	
Windows Busy Typ (S0)	520.876		524.39		511.868	
Windows Busy Max (S0)	652.17		675.269		648.144	
Sleep (S3)	6.619	5.118	7.063	5.596	6.517	4.947
Off (S5)	2.115	2.047	2.15	2.081	2.081	2.047
Zero Power Mode (ErP)	0.785		0.819		0.751	

#### Z2 Mini G5 Configuration #4

#### ENERGY STAR CERTIFIED

Processor Info	CPU Xeon W-1250 3.3GHz 6C80W
Memory Info	16GB (2x 8GB) 2666 MHz DDR4 ECC
Graphics Info	T2000 Graphics
Disks/Optical/Floppy	1x SATA 1TB SSD Z Turbo
Power Supply	280W

#### Energy Consumption (Watts)

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows long Idle (S0)	15.48		15.94		15.25	
Windows short Idle (S0)	19.47		19.5		19.13	
Windows Busy Typ (S0)	120.03		123.49		118.69	
Windows Busy Max (S0)	175.99		176.23		172.33	
Sleep (S3)	1.21	1.09	1.23	1.11	1.18	1.06
Off (S5)	0.64	0.63	0.66	0.64	0.6	0.59
Zero Power Mode (ErP)	0.22		0.24		0.21	

#### Heat Dissipation (Btu/hr)

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
Windows long Idle (S0)	52.818		54.387		52.033	
Windows short Idle (S0)	66.432		66.534		65.272	
Windows Busy Typ (S0)	409.542		421.348		404.97	
Windows Busy Max (S0)	600.478		601.297		587.99	
Sleep (S3)	4.129	3.719	4.197	3.787	4.026	3.617
Off (S5)	2.184	2.15	2.252	2.184	2.047	2.013
Zero Power Mode (ErP)	0.751		0.819		0.717	

### Declared Noise Emissions

### System Technical Specifications

<b>System Configuration (Entry level)</b>	<b>Processor Info</b>	W-1250P COMET LAKE WS P-1 6c LGA 125W WE1P 6(f)+2 vPro™ QSS / W-1250P COMET LAKE WS Q-0 6c LGA 4.1 GHz 125W QULG vPro™ Supplemental QS	
	<b>Memory Info</b>	Hynix (TG) 8GB 3200 DDR4 SODIMM ECC x2	
	<b>Graphics Info</b>	T2000	
	<b>Disks/Optical/Floppy</b>	SSD Z Turbo Drive 256GB 2280 PCIe NVMe Self Encrypted OPAL2 Three Layer Cell SS	
	<b>Power Supply</b>	280W	
<b>Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)</b>		<b>Sound Power (LWAd, bels)</b>	<b>Deskside Sound Pressure (LpAm, decibels)</b>
	<b>Idle</b>	TBD	TBD
	<b>Hard drive Operating (random reads)</b>	SSD 512GB M.2 2280 PCIe NVMe Three Layer Cell 3rd	
<b>System Configuration (Mid-level)</b>	<b>Processor Info</b>	W-1290 COMET LAKE WS P-1 10c LGA 80W WE3 vPro™ QSK QS / W-1290 COMET LAKE WS Q-0 10c LGA 3.2 GHz 80W QUTJ vPro™ Supplemental QS	
	<b>Memory Info</b>	Samsung (TH) 8GB 3200 DDR4 SODIMM ECC x1	
	<b>Graphics Info</b>	T1000	
	<b>Disks/Optical/Floppy</b>	NA	
	<b>Power Supply</b>	280W	
<b>Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)</b>		<b>Sound Power (LWAd, bels)</b>	<b>Deskside Sound Pressure (LpAm, decibels)</b>
	<b>Idle</b>	TBD	TBD
	<b>Hard drive Operating (random reads)</b>	HDD 500GB 7200RPM SATA SFF Self Encrypted Drive OPAL2	
<b>System Configuration (High-end)</b>	<b>Processor Info</b>	I5-10400 COMET LAKE G-0 6c LGA 65W MS0 QS	
	<b>Memory Info</b>	Hynix (TG) 8GB 3200 DDR4 SODIMM ECC x1	
	<b>Graphics Info</b>	Intel UHD Graphics	
	<b>Disks/Optical/Floppy</b>	SSD Z Turbo Drive 512GB 2280 Three Layer Cell 2nd	
	<b>Power Supply</b>	280W	
<b>Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)</b>		<b>Sound Power (LWAd, bels)</b>	<b>Deskside Sound Pressure (LpAm, decibels)</b>
	<b>Idle</b>	TBD	TBD
	<b>Hard drive Operating (random reads)</b>	HDD 1TB 7200RPM 7mm SATA 2.5in	
<b>System Configuration (Mid-level)</b>	<b>Processor Info</b>	I3-10320 COMET LAKE G-0 6c LGA 65W T3 4(f)+2 QS	
	<b>Memory Info</b>	Micron (TF) 8GB 3200 DDR4 SODIMM ECC x2	
	<b>Graphics Info</b>	Intel UHD Graphics	
	<b>Disks/Optical/Floppy</b>	SSD Z Turbo Drive 512GB 2280 Three Layer Cell 2nd	
	<b>Power Supply</b>	180W	
		<b>Sound Power (LWAd, bels)</b>	<b>Deskside Sound Pressure (LpAm, decibels)</b>

### System Technical Specifications

<b>Declared Noise Emissions</b> (in accordance with ISO 7779 and ISO 9296)	<b>Idle</b>	TBD	TBD
	<b>Hard drive Operating</b> (random reads)	HDD 1TB 7200RPM 7mm SATA 2.5in	
<b>System Configuration</b> <b>(High-end)</b>	<b>Processor Info</b>	I3-10100 COMET LAKE G-0 6c LGA 65W T1 4(f)+2 QS	
	<b>Memory Info</b>	Micron (TF) 8GB 3200 DDR4 SODIMM ECC x2	
	<b>Graphics Info</b>	Intel UHD Graphics	
	<b>Disks/Optical/Floppy</b>	ZTRB HP Z Turbo Drive QX310 256GB SSD	
	<b>Power Supply</b>	180W	
<b>Declared Noise Emissions</b> (in accordance with ISO 7779 and ISO 9296)		<b>Sound Power</b> (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)
	<b>Idle</b>	TBD	TBD
	<b>Hard drive Operating</b> (random reads)	HDD 1TB 7200RPM 7mm SATA 2.5in	
<b>System Configuration</b> <b>(Mid-level)</b>	<b>Processor Info</b>	I9-10900 COMET LAKE P-1 10c LGA 65W P2 vPro™ QS	
	<b>Memory Info</b>	Micron (TF) 4GB (1x4GB) 3200 DDR4 SODIMM NECC x2	
	<b>Graphics Info</b>	Intel UHD Graphics	
	<b>Disks/Optical/Floppy</b>	ZTRB HP Z Turbo Drive QX310 256GB SSD	
	<b>Power Supply</b>	180W	
<b>Declared Noise Emissions</b> (in accordance with ISO 7779 and ISO 9296)		<b>Sound Power</b> (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)
	<b>Idle</b>	TBD	TBD
	<b>Hard drive Operating</b> (random reads)	ZTRB HP Z Turbo Drive QX310 256GB SSD	
<b>System Configuration</b> <b>(High-end)</b>	<b>Processor Info</b>	I5-10500 COMET LAKE G-0 6c LGA 65W MS1 vPro™ QS	
	<b>Memory Info</b>	Samsung (TH) 4GB (1x4GB) 3200 DDR4 SODIMM NECC x2	
	<b>Graphics Info</b>	Intel UHD Graphics	
	<b>Disks/Optical/Floppy</b>	SSD Z Turbo Drive 512GB 2280 PCIe NVMe Self Encrypted OPAL2 Three Layer Cell SS	
	<b>Power Supply</b>	180W	
<b>Declared Noise Emissions</b> (in accordance with ISO 7779 and ISO 9296)		<b>Sound Power</b> (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)
	<b>Idle</b>	TBD	TBD
	<b>Hard drive Operating</b> (random reads)	HDD 1TB 7200RPM 7mm SATA 2.5in	

### Environmental Requirements

#### Temperature

Operating: 5° to 35° C (40° to 95° F)  
 Non-operating: -40° to 60° C (-40° to 140° F)  
 Maximum rate of change: 10°C/hr

#### Humidity

Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb  
 Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb

#### Maximum Altitude

Operating (with Rotational Hard Drives): 3,048 m (10,000 feet)  
 Operating (with only Solid-State Drives): 5,000 m (16,404 feet)  
 Non-operating: 12,192 m (40,000 feet)

### System Technical Specifications

<b>Dynamic</b>	<p>Maximum operating temperature is reduced as altitude increases. See Cooling for details.</p> <p><b>Shock</b> Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g) square: 422 cm/s, 20g</p>
<b>Cooling</b>	<p><b>Vibration</b> Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g<sup>2</sup>/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g<sup>2</sup>/Hz</p> <p>Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation, up to 3048 m (10,000 feet)</p>

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### System Technical Specifications

#### Physical Security and Serviceability

<b>Access Panel</b>	Tool-less Has to remove Top panel before Bottom panel be removed.
<b>Optical Drive</b>	No
<b>Hard Drives</b>	HDD cage requires the use of a screwdriver to remove the HDD
<b>Expansion Cards</b>	M.2 module requires a screwdriver to service and replace. An option card requires a screwdriver to service and replace.
<b>Processor Socket</b>	Tool-less, except for the processor heatsink
<b>Blue User Touch Points</b>	Yes, on internal chassis mechanisms
<b>Color-coordinated Cables and Connectors</b>	Yes
<b>Memory</b>	Tool-less
<b>System Board</b>	Screw-In
<b>Dual Color Power and HD LED on Front of Computer</b>	The Power LED is on the front of the system, but the HDD LED is located on the Rear of the system
<b>Restore CD/DVD Set</b>	Consists of an operating system DVD (OSDVD) and a driver DVD (DRDVD). OSDVD restores the original operating system. DRDVD will provide all drivers for the system. The DRDVD may also contain applications that originally shipped with the system for optional installation. Applications can also be obtained from HP.com. OSDVD and DRDVD are orderable with the system and available from HP Support.
<b>Dual Function Front Power Switch</b>	Yes, causes a fail-safe power off when held for 4 seconds (default) or 15 seconds (can be configured by F10 BIOS setup\Advanced\System Options\Power button override)
<b>Padlock Support</b>	No
<b>Cable Lock Support</b>	Yes, Kensington Cable Lock (optional): Locks top cover from being opened and secures chassis to furniture to prevent theft 3 mm x 7 mm slot at rear of system
<b>Universal Chassis Clamp Lock Support</b>	No
<b>Solenoid Lock and Hood Sensor</b>	Only Hood Sensor(optional)
<b>Rear Port Control Cover</b>	No
<b>Serial, USB, Audio, Network, Enable/Disable Port Control</b>	Yes, enables or disables serial, USB, audio, and network ports (parallel port is not supported on the Z2 Mini G5)
<b>Power-On Password</b>	No
<b>3.3V Aux Power LED on System PCA</b>	No
<b>NIC LEDs (integrated) (Green &amp; Amber)</b>	Yes
<b>CPUs and Heatsinks</b>	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less



### System Technical Specifications

<b>Power Supply Diagnostic LED</b>	Yes; this is located on the Rear of the chassis and combined with the HDD LED. When the PSU adapter is plugged in, and the unit is powered off, the Power OK LED will glow.
<b>Front Power Button</b>	Yes
<b>Front Power LED</b>	Yes, white (normal), red (fault)
<b>Front Hard Drive Activity LED</b>	HDD LED is located on the Rear of the chassis
<b>Front ODD Activity LED</b>	No
<b>Internal Speaker</b>	Yes
<b>Cooling Solution</b>	Air cooled forced convection
<b>Power Supply Fans</b>	No
<b>Memory Heatsink Fan</b>	No
<b>Access Panel Key Lock</b>	The Kensington lock slot on the chassis serves this purpose
<b>Integrated Chassis Handles</b>	No
<b>Power Supply Flash ROM</b>	No Yes
<b>Diagnostic Power Switch LED on board</b>	Yes
<b>Clear CMOS Button</b>	Yes
<b>CMOS Battery Holder</b>	Yes
<b>DIMM Connectors</b>	Yes

### BIOS

<b>BIOS 32-bit Services</b>	BIOS supports 64-bit Operating systems.
<b>PCI 3.0 Support</b>	Full BIOS support for PCI Express through industry standard interfaces.
<b>ATAPI</b>	ATAPI Removable Media Device BIOS Specification Version 1.0.
<b>BBS</b>	BIOS Boot Specification v1.01.
<b>WMI Support</b>	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.
<b>BIOS Boot Spec 1.01+</b>	Provides more control over how and from what devices the workstation will boot.
<b>BIOS Power On ROM Based Computer Setup Utility (F10)</b>	Users can define a specific date and time for the system to power on. Review and customize system configuration settings controlled by the BIOS.
<b>System/Emergency ROM Flash Recovery with Video Replicated Setup</b>	Recovers system BIOS in corrupted Flash ROM. Saves BIOS settings to USB flash device in human readable file (HpSetup.txt). BiosConfigurationUtility.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).

### System Technical Specifications

<b>SMBIOS</b>	System Management BIOS 3.2, for system management information.
<b>Boot Control</b>	Disables the ability to boot from removable media on supported devices.
<b>Memory Change Alert</b>	Alerts management console if memory is removed or changed.
<b>Thermal Alert</b>	Monitors the temperature state within the chassis. Three modes: <ul style="list-style-type: none"> <li>• <b>NORMAL</b> - normal temperature ranges.</li> <li>• <b>ALERTED</b> - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.</li> <li>• <b>SHUTDOWN</b> - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.</li> </ul>
<b>Remote ROM Flash</b>	Provides secure, fail-safe ROM image management from a central network console.
<b>ACPI (Advanced Configuration and Power Management Interface)</b>	Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 6.0 for full compatibility with 64-bit operating systems.
<b>Ownership Tag</b>	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.
<b>Remote Wakeup/Remote Shutdown</b>	System administrators can power on, restart, and power off a client computer from a remote location.
<b>Instantly Available PC (Suspend to RAM - ACPI sleep state S3)</b>	Allows for very low power consumption with quick resume time.
<b>Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)</b>	Allows a new or existing system to boot over the network and download software, including the operating system.
<b>ROM revision levels</b>	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS and WMI) so that management SW applications can use and report this information.
<b>System board revision level</b>	Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.
<b>Start-up Diagnostics (Power-on Self-Test)</b>	Assesses system health at boot time with selectable levels of testing.
<b>Auto Setup when new hardware installed</b>	System automatically detects addition of new hardware.
<b>Keyboard-less Operation</b>	The system can be booted without a keyboard.
<b>Localized ROM Setup</b>	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 14 languages with local keyboard mappings.
<b>Asset Tag</b>	The user or MIS to set a unique tag string in non-volatile memory.
<b>Per-slot Control</b>	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.
<b>Adaptive Cooling</b>	Control parameters are set according to detected hardware configuration for optimal acoustics.
<b>Pre-boot Diagnostics Industry Standard</b>	(Pre-video) critical errors are reported via beeps and blinks on the power LED. Revision Supported by the BIOS
<b>UEFI Specification Revision 2.7</b>	
<b>ACPI</b>	Advanced Configuration and Power Management Interface, Version 6.0
<b>ATA (IDE)</b>	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
<b>CD Boot</b>	"El Torito" Bootable CD-ROM Format Specification Version 1.0
<b>EDD</b>	Enhanced Disk Drive Specification Version 1.1 BIOS Enhanced Disk Drive Specification Version 3.0
<b>EHCI</b>	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0
<b>PCI</b>	PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7

### System Technical Specifications

<b>PCI Express</b>	PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0
<b>SATA</b>	Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0
<b>SPD</b>	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B
<b>TPM</b>	Trusted Computing Group TPM Specification Version 2.0 (Infineon SLB 9670). Common Criteria EAL4+ certified. FIPS 140-2 Certification TCG TPM Certified products list: <a href="http://www.trustedcomputinggroup.org/certification/tpm-certified-products/">http://www.trustedcomputinggroup.org/certification/tpm-certified-products/</a>
<b>UHCI</b>	Universal Host Controller Interface Design Guide, Revision 1.1
<b>USB</b>	Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 Specification
<b>SMBIOS</b>	System Management BIOS Reference Specification, Version 3.2 External BIOS simulator found at: <a href="http://csrsm1.itcs.hp.com/">http://csrsm1.itcs.hp.com/</a>

### Service, Support, and Warranty

On-site Warranty and Service<sup>1</sup>: Three-years, limited warranty and service offering delivers on-site, next business-day<sup>2</sup> service for parts and labor and includes free telephone support<sup>3</sup> 8am - 5pm. Global coverage<sup>2</sup> ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. 24/7 operation will not void the HP warranty.

**NOTE 1:** Terms and conditions may vary by country. Certain restrictions and exclusions apply.

**NOTE 2:** On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

**NOTE 3:** Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.

HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <http://www.hp.com/go/lookuptool>. Service levels and response times for HP Care Packs may vary depending on your geographic location.

### Social and Environmental Responsibility

#### Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT® Gold registered in the United States. See <http://www.epeat.net> for registration status in your country.
- TCO Certified configurations available

#### System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Workstation model is based on a "Typically Configured Workstation".

#### Energy Consumption (in accordance with US ENERGY STAR® test method)

	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	22.14 W	25.47 W	24.83 W

### System Technical Specifications

Normal Operation (Long idle)	20.37 W	19.53 W	19.39 W
Sleep	2.53 W	1.96 W	2.34 W
Off	0.564 W	0.66 W	0.66 W

**NOTE:**

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	75.72 BTU/hr	87.11 BTU/hr	84.92 BTU/hr
Normal Operation (Long idle)	69.67 BTU/hr	66.79 BTU/hr	66.31 BTU/hr
Sleep	8.65 BTU/hr	6.7 BTU/hr	8 BTU/hr
Off	1.93 BTU/hr	2.26 BTU/hr	2.26 BTU/hr

**\*NOTE:** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L <sub>WAd</sub> , bels)	Sound Pressure (L <sub>pAm</sub> , decibels)
Typically Configured – Idle	2.88	15.54
Fixed Disk – Random writes	3.44	23.04

#### Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:  
Mercury greater than 1ppm by weight  
Cadmium greater than 20ppm by weight

Battery size: Not Applicable

Battery type: Not Applicable

#### Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680.1 (EPEAT) standard at the <Gold> level, see [www.epeat.net](http://www.epeat.net)
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 60.0% post-consumer recycled plastic (by wt.)
- This product is 96.6% recycle-able when properly disposed of at end of life.

#### Packaging Materials

<b>External:</b>	PAPER/Corrugated	674 g
	PAPER/Molded Pulp	276 g
<b>Internal:</b>	PLASTIC/Polyethylene low density - LDPE	19 g

### System Technical Specifications

The plastic packaging material contains at least 50% recycled content.

The corrugated paper packaging materials contains at least 70% recycled content.

#### Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

<http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf>):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants – may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) – except for wires and cables, has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

#### Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

#### End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <http://www.hp.com/go/reuse-recycle> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the HP web site at: <http://www.hp.com/go/recyclers>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

## System Technical Specifications

**HP Inc. Corporate Environmental Information** For more information about HP's commitment to the environment:

Global Citizenship Report

<http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html>

Eco-label certifications

<http://www8.hp.com/us/en/hp-information/environment/ecolabels.html>

ISO 14001 certificates:

<http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842>

and

<http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf>

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### System Technical Specifications

#### Manageability

**Remote Manageability Software Solutions** The HP Z2 G5 Workstation is supported on the following remote manageability software consoles:

- LANDesk Management Suite (HP recommended solution)
- Microsoft System Center Configuration Manager

For questions or support for manageability needs, please visit  
<http://www.hp.com/go/clientmanagement>

**HP Image Assistant** Visit: <http://ftp.hp.com/pub/caps-softpaq/cmit/HPIA.html>

**System Software Manager** For questions or support for SSM, please visit: <http://www.hp.com/go/ssm>

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### Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers—no special programs, no additional cost, no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering
		Intel Core i3-10100 3.6 4C 65W processor
		Intel Core i5-10500 3.1 6C 65W processor
		Intel Core i5-10600 3.3 6C 65W processor
		Intel Core i7-10700 2.9 8C 65W processor
		Intel Xeon W-1250 3.3 6C 80W processor
		Intel Xeon W-1250P 4.1 6C 125W processor

Hard Drives	Product #	Offering
		1TB 7200RPM 9.5mm SATA 2.5 HDD

Graphics	Product #	Offering
		AMD Radeon™ Pro WX 3200 4GB



## Technical Specifications - Processors

### 10th Generation Intel Core Processors

Intel® Core™ i9-10900K Processor

Intel® Core™ i9-10900 Processor

Intel® Core™ i9-10900F Processor<sup>1</sup>

Intel® Core™ i9-10850K Processor

Intel® Core™ i7-10700K Processor

Intel® Core™ i7-10700 processor

Intel® Core™ i5-10600K processor

Intel® Core™ i5-10600 processor

Intel® Core™ i5-10500 processor

Intel® Core™ i5-10400 processor

Intel® Core™ i5-10400F Processor<sup>1</sup>

Intel® Core™ i3-10320 processor<sup>1</sup>

Intel® Core™ i3-10300 processor<sup>1</sup>

Intel® Core™ i3-10100 processor

### Intel Xeon W Processors

Intel® Xeon® W-1290P processor

Intel® Xeon® W-1290 processor<sup>1</sup>

Intel® Xeon® W-1270P processor<sup>1</sup>

Intel® Xeon® W-1270 processor

Intel® Xeon® W-1250P processor

Intel® Xeon® W-1250 processor

**NOTE 1:** Available in Q4, 2020

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### Technical Specifications - Hard Drives

<b>SATA Hard Drives for HP Workstations</b>	<b>500GB SATA 7200 rpm 6Gb/s 2.5" HDD</b>	<b>Capacity</b>	500GB
		<b>Protocol</b>	SATA
		<b>Form Factor</b>	SFF (2.5")
		<b>Controller</b>	AHCI
		<b>Rated for 24/7/365 operation</b>	NO
		<b>Physical Size (Height)</b>	0.28 in; .7 cm
		<b>Physical Size (Width)</b>	2.75 in; 6.99 cm
		<b>Media Diameter</b>	2.5 in; 6.36 cm
		<b>Interface</b>	Serial ATA (6Gb/s), NCQ enabled
		<b>Synchronous Transfer Rate (Maximum)</b>	Up to 600MB/s*
		<b>Operating Temperature</b>	32° to 140° F (5° to 55° C)

\*Actual performance may vary.

	<b>1TB SATA 7200 rpm 6Gb/s 2.5" HDD</b>	<b>Capacity</b>	1TB
		<b>Protocol</b>	SATA
		<b>Form Factor</b>	SFF (2.5")
		<b>Controller</b>	AHCI
		<b>Rated for 24/7/365 operation</b>	NO
		<b>Physical Size (Height)</b>	0.28 in; .7 cm
		<b>Physical Size (Width)</b>	2.75 in; 6.99 cm
		<b>Media Diameter</b>	2.5 in; 6.36 cm
		<b>Interface</b>	Serial ATA (6Gb/s), NCQ enabled
		<b>Synchronous Transfer Rate (Maximum)</b>	Up to 600MB/s*

\*Actual performance may vary.

	<b>2TB SATA 7200 rpm 6Gb/s 2.5" HDD</b>	<b>Capacity</b>	2TB
		<b>Protocol</b>	SATA
		<b>Form Factor</b>	SFF (2.5")
		<b>Controller</b>	AHCI
		<b>Physical Size (Height)</b>	0.28 in; .7 cm
		<b>Physical Size (Width)</b>	2.75 in; 6.99 cm
		<b>Media Diameter</b>	2.5 in; 6.36 cm
		<b>Operating Temperature</b>	32° to 140° F (5° to 55° C)

\*Actual performance may vary.

	<b>500GB SATA 7.2K SED 2.5" HDD</b>	<b>Capacity</b>	500GB
		<b>Protocol</b>	SATA
		<b>Form Factor</b>	2.5"
		<b>Physical Size (Height)</b>	0.275 in; 0.7 cm
		<b>Physical Size (Width)</b>	2.5 in; 6.36 cm
		<b>Media Diameter</b>	2.75 in; 6.99 cm

### Technical Specifications - Hard Drives

<b>Interface</b>	Serial ATA (6Gb/s), NCQ enabled	
<b>Synchronous Transfer Rate (Maximum)</b>	Up to 600MB/s*	
<b>Buffer</b>	64MB	
<b>Seek Time (typical reads, includes controller overhead, including settling)</b>	<b>Single Track</b>	1ms*
	<b>Average</b>	4.2ms*
	<b>Full Stroke</b>	25ms (Typical)*
<b>Rotational Speed</b>	7,200 rpm	
<b>Operating Temperature</b>	32° to 131° F (0° to 60° C)	
<b>Self-Encrypting Drive Support</b>	Yes	

\*Actual performance may vary.

#### HP 256GB SATA 6Gb/s SSD

<b>Capacity</b>	256GB
<b>Protocol</b>	SATA
<b>Form Factor</b>	2.5"
<b>Physical Size (Height)</b>	0.28 in; 0.7 cm
<b>Physical Size (Width)</b>	Physical Size
<b>Synchronous Transfer Rate (Maximum)</b>	Up to 550MB/s (Sequential Read)*
<b>Operating Temperature</b>	32° to 158° F (0° to 70° C)

\*Actual performance may vary.

#### PCIe SSDs for HP Workstations

##### HP Z Turbo Drv 256GB TLC PCIe SSD (Z2G5)

<b>Capacity</b>	256GB	
<b>Protocol</b>	PCIe	
<b>Form Factor</b>	M.2 in native slot on motherboard	
<b>Controller</b>	NVMe	
<b>NAND Type</b>	3D TLC	
<b>Endurance</b>	75TBW (TB Written)	
<b>Reliability (MTBF)</b>	1.5M hours	
<b>Interface</b>	PCI Express 3.0 x4	
<b>Operating Temperature</b>	32° to 158° F (0° to 70° C)	
<b>Performance</b>	<b>Sequential Read</b>	2800 MB/s*
	<b>Sequential Write</b>	1100MB/s*
	<b>Random Read</b>	250K IOPS*
	<b>Random Write</b>	180K IOPS*

\*Actual performance may vary.

##### HP Z Turbo Drv 512GB TLC PCIe SSD (Z2G5)

<b>Capacity</b>	512GB
<b>Protocol</b>	PCIe
<b>Form Factor</b>	M.2 in native slot on motherboard
<b>Controller</b>	NVMe
<b>NAND Type</b>	3D TLC

### Technical Specifications - Hard Drives

<b>Endurance</b>	150TBW (TB Written)	
<b>Reliability (MTBF)</b>	1.5M hours	
<b>Interface</b>	PCI Express 3.0 x4 electrical	
<b>Operating Temperature</b>	32° to 158° F (0° to 70° C)	
<b>Performance</b>	<b>Sequential Read</b>	2800 MB/s*
	<b>Sequential Write</b>	1600MB/s*
	<b>Random Read</b>	260K IOPS*
	<b>Random Write</b>	260K IOPS*

\*Actual performance may vary.

#### HP Z Turbo Drv 1TB TLC PCIe SSD (Z2G5)

<b>Capacity</b>	1TB	
<b>Protocol</b>	PCIe	
<b>Form Factor</b>	M.2 in native slot on motherboard	
<b>Controller</b>	NVMe	
<b>NAND Type</b>	3D TLC	
<b>Endurance</b>	300TBW (TB Written)	
<b>Reliability (MTBF)</b>	1.5M hours	
<b>Interface</b>	PCI Express 3.0 x4 electrical	
<b>Operating Temperature</b>	32° to 158° F (0° to 70° C)	
<b>Performance</b>	<b>Sequential Read</b>	3000 MB/s*
	<b>Sequential Write</b>	1700MB/s*
	<b>Random Read</b>	360K IOPS*
	<b>Random Write</b>	330K IOPS*

\*Actual performance may vary.

#### HP Z Turbo Drv 2TB TLC PCIe SSD (Z2G5)

<b>Capacity</b>	2TB	
<b>Protocol</b>	PCIe	
<b>Form Factor</b>	M.2 in native Slot on motherboard	
<b>Controller</b>	NVMe	
<b>NAND Type</b>	3D TLC	
<b>Endurance</b>	600TBW (TB Written)	
<b>Reliability (MTBF)</b>	1.5M hours	
<b>Interface</b>	PCI Express 3.0 x4 electrical	
<b>Operating Temperature</b>	32° to 158° F (0° to 70° C)	
<b>Performance</b>	<b>Sequential Read</b>	3000 MB/s*
	<b>Sequential Write</b>	2100MB/s*
	<b>Random Read</b>	320K IOPS*
	<b>Random Write</b>	265K IOPS*

\*Actual performance may vary.

#### HP Z Turbo Drv 256GB TLC PCIe SED OPAL2 (Z2G5)

<b>Capacity</b>	256GB	
<b>Protocol</b>	PCIe	
<b>Form Factor</b>	M.2 in native Slot on motherboard	
<b>Controller</b>	NVMe	
<b>NAND Type</b>	3D TLC	

### Technical Specifications - Hard Drives

<b>Endurance</b>	75TBW (TB Written)	
<b>Reliability (MTBF)</b>	1.5M Hours	
<b>Interface</b>	PCI Express 3.0 x4 electrical	
<b>Operating Temperature</b>	32° to 158° F (0° to 70° C)	
<b>Performance</b>	<b>Sequential Read</b>	2800MB/s*
	<b>Sequential Write</b>	1100MB/s*
	<b>Random Read</b>	250K IOPS*
	<b>Random Write</b>	180K IOPS*
<b>Self-Encrypting Drive Support</b>	OPAL2	

\*Actual performance may vary.

#### HP Z Turbo Drv 512GB TLC PCIe SED OPAL2 (Z2G5)

<b>Capacity</b>	512GB	
<b>Protocol</b>	PCIe	
<b>Form Factor</b>	M.2 in native Slot on motherboard	
<b>Controller</b>	NVMe	
<b>NAND Type</b>	3D TLC	
<b>Endurance</b>	150TBW (TB Written)	
<b>Reliability (MTBF)</b>	1.5M Hours	
<b>Interface</b>	PCI Express 3.0 x4 electrical	
<b>Operating Temperature</b>	32° to 158° F (0° to 70° C)	
<b>Performance</b>	<b>Sequential Read</b>	2800MB/s*
	<b>Sequential Write</b>	1600MB/s*
	<b>Random Read</b>	260K IOPS*
	<b>Random Write</b>	260K IOPS*
<b>Self-Encrypting Drive Support</b>	OPAL2	

\*Actual performance may vary.

#### HP Z Turbo Drv 1TB TLC PCIe SED OPAL2 (Z2G5)

<b>Capacity</b>	1TB	
<b>Protocol</b>	PCIe	
<b>Form Factor</b>	M.2 in native Slot on motherboard	
<b>Controller</b>	NVMe	
<b>NAND Type</b>	3D TLC	
<b>Endurance</b>	300TBW (TB Written)	
<b>Reliability (MTBF)</b>	1.5M Hours	
<b>Interface</b>	PCI Express 3.0 x4 electrical	
<b>Operating Temperature</b>	32° to 158° F (0° to 70° C)	
<b>Performance</b>	<b>Sequential Read</b>	3000MB/s*
	<b>Sequential Write</b>	1700MB/s*
	<b>Random Read</b>	360K IOPS*
	<b>Random Write</b>	330K IOPS*
<b>Self-Encrypting Drive Support</b>	OPAL2	

\*Actual performance may vary.

### Technical Specifications - Hard Drives

**HP Z Turbo Drv 2TB  
TLC PCIe SED  
OPAL2 (Z2G5)**

<b>Capacity</b>	2TB	
<b>Protocol</b>	PCIe	
<b>Form Factor</b>	M.2 in native Slot on motherboard	
<b>Controller</b>	NVMe	
<b>NAND Type</b>	3D TLC	
<b>Endurance</b>	600TBW (TB Written)	
<b>Reliability (MTBF)</b>	1.5M Hours	
<b>Interface</b>	PCI Express 3.0 x4 electrical	
<b>Operating Temperature</b>	32° to 158° F (0° to 70° C)	
<b>Performance</b>	<b>Sequential Read</b>	3000MB/s*
	<b>Sequential Write</b>	2100MB/s*
	<b>Random Read</b>	320K IOPS*
	<b>Random Write</b>	265K IOPS*
<b>Self-Encrypting Drive Support</b>	OPAL2	

\*Actual performance may vary.

### Technical Specifications - Graphics

<b>AMD Radeon™ Pro WX 3200 4GB Graphics</b>	<b>Form Factor</b>	Mobile PCI Express Custom Module
	<b>Power</b>	35W
	<b>Bus Type</b>	PCI Express 3.0 x8
	<b>Memory</b>	4GB GDDR5
	<b>Connectors</b>	3x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.
	<b>Maximum Resolution</b>	4096x2160 x 24 bpp @ 60Hz
	<b>Supported Graphics APIs</b>	DirectX®12 OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0
	<b>Available Graphics Drivers</b>	Windows 11 Windows 10 Linux® 64-bit (selected Enterprise distributions)
		HP qualified drivers may be preloaded or available from the HP support Web site: <a href="http://welcome.hp.com/country/us/en/support.html">http://welcome.hp.com/country/us/en/support.html</a>

<b>Nvidia® Quadro® P620 4GB Graphics</b>	<b>Form Factor</b>	Mobile PCI Express Custom Module
	<b>Power</b>	35W
	<b>Bus Type</b>	PCI Express 3.0 x16
	<b>Memory</b>	4GB GDDR5
	<b>Connectors</b>	3x DisplayPort™ 1.2 – HDR ready connectors with HBR2 and MST support.
	<b>Maximum Resolution</b>	4096x2160 x 24 bpp @ 60Hz
	<b>Supported Graphics APIs</b>	DirectX®12 OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0
	<b>Available Graphics Drivers</b>	Windows 11 Windows 10 Linux® 64-bit (selected Enterprise distributions)
		HP qualified drivers may be preloaded or available from the HP support Web site: <a href="http://welcome.hp.com/country/us/en/support.html">http://welcome.hp.com/country/us/en/support.html</a>

<b>Nvidia® Quadro® T1000 4GB Graphics</b>	<b>Form Factor</b>	Mobile PCI Express Custom Module
	<b>Power</b>	50W
	<b>Bus Type</b>	PCI Express 3.0 x16
	<b>Memory</b>	4GB GDDR6
	<b>Connectors</b>	3x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.
	<b>Maximum Resolution</b>	5120 x 3200 @ 60Hz
	<b>Supported Graphics APIs</b>	DirectX®12 OpenGL® 4.5

### Technical Specifications - Graphics

	OpenCL™ 2.0 Vulkan™ 1.0
<b>Available Graphics Drivers</b>	Windows 11 Windows 10 Linux® 64-bit (selected Enterprise distributions)
	HP qualified drivers may be preloaded or available from the HP support Web site: <a href="http://welcome.hp.com/country/us/en/support.html">http://welcome.hp.com/country/us/en/support.html</a>

<b>Nvidia® Quadro® T2000 4GB Graphics</b>	<b>Form Factor</b>	Mobile PCI Express Custom Module
	<b>Power</b>	60W
	<b>Bus Type</b>	PCI Express 3.0 x16
	<b>Memory</b>	4GB GDDR6
	<b>Connectors</b>	3x DP (DisplayPort™) 1.4 Connectors
	<b>Maximum Resolution</b>	5120 x 3200 @ 60Hz <i>*Requires 2 DisplayPorts™ to be plugged into a 5K monitor.</i>
	<b>Supported Graphics APIs</b>	DirectX®12.1 OpenGL® 4.6 OpenCL™ 2.0 Vulkan™ 1.0
	<b>Available Graphics Drivers</b>	Windows 11 Windows 10 Linux® 64-bit (selected Enterprise distributions)
		HP qualified drivers may be preloaded or available from the HP support Web site: <a href="http://welcome.hp.com/country/us/en/support.html">http://welcome.hp.com/country/us/en/support.html</a>

<b>Nvidia® Quadro® RTX 3000 6GB Graphics</b>	<b>Form Factor</b>	Mobile PCI Express Custom Module
	<b>Power</b>	60W
	<b>Bus Type</b>	PCI Express 3.0 x16
	<b>Memory</b>	6GB GDDR6
	<b>Connectors</b>	3x DP (DisplayPort™) 1.4 Connectors
	<b>Maximum Resolution</b>	5120 x 3200 @ 60Hz* <i>*Requires 2 DisplayPorts™ to be plugged into a 5K monitor.</i>
	<b>Supported Graphics APIs</b>	DirectX®12 OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0
	<b>Available Graphics Drivers</b>	Windows 11 Windows 10 Linux® 64-bit (selected Enterprise distributions)
		HP qualified drivers may be preloaded or available from the HP support Web site: <a href="http://welcome.hp.com/country/us/en/support.html">http://welcome.hp.com/country/us/en/support.html</a>



### Technical Specifications - Networking and Communications

<b>Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro™ with Intel® AMT 12.0)</b>	<b>Connector</b>	RJ-45
	<b>Controller</b>	Intel® I219LM GbE platform LAN connect networking controller
	<b>Memory</b>	3 KB Tx and 3KB Rx FIFO packet buffer memory
	<b>Data Rates Supported</b>	10/100/1000 Mbps
	<b>Compliance</b>	802.1as/1588, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i, 802.3u, 802.3z
	<b>Bus Architecture</b>	PCI Express and SMBus
	<b>Data Transfer Mode</b>	PCIe-based interface for active state operation (S0 state) and SMBus for host and management traffic (Sx low power state)
	<b>Power Requirement</b>	Requires 3.3V (integrated regulators for core Vdc)
	<b>Boot ROM Support</b>	Yes
	<b>Network Transfer Mode</b>	Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)
	<b>Network Transfer Rate</b>	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	<b>Management Capabilities</b>	vPro™, WOL, auto MDI crossover, PXE, Multi-port teaming, RSS, ACPI, Advanced cable diagnostic, loopback modes, AMT 12.0 support, Circuit Breaker, VLAN, Multicast Listener Discovery (MLD)

<b>Intel® AX201 802.11 a/b/g/n/ac/ax WLAN + Bluetooth 5.0 M.2</b>	<b>WLAN Standards</b>	802.11a/b/g/n/ac/ax Wave 6, Dual band 2x2 with up to 2.4Gbps speed (theoretical maximum); Up to 3x faster than 802.11ac and up to 4x capacity in congested environments than 802.11ac
	<b>Antenna</b>	2x2 Dual-Band
	<b>Bluetooth Standards</b>	5
	<b>Operating Temperature</b>	32° to 131° F (0° to 55° C)
	<b>Interface</b>	M.2 CNVio
	<b>Dimensions</b>	M.2 2230
	<b>Kit Contents</b>	Not Available

**NOTE:** Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ax) is backwards compatible with prior 802.11 specs

<b>Allied Telesis 1GbE LC Fiber 2pc Module</b>	<b>Network Interface(s)</b>	1 LC Fiber Connection
	<b>System Interface</b>	PCI Express Gen1.1x1 (via WLAN M.2 interface)
	<b>Network Cable</b>	1GbE over Multimode LC Fiber. Distance is dependent upon network cable: OM1 50/125um 500 MHz:km 550m OM2 62.5/125um 200 MHz:km 275m OM2 62.5/125um 160MHz:km 220m
	<b>Data Rates Supported</b>	1 Gbps
	<b>LED Indicators</b>	Link/Activity LED (Green): Off = No Link, Solid = Link, Blinking = Activity
	<b>Controller</b>	Broadcom BCM57762

### Technical Specifications - Networking and Communications

<b>Compliance</b>	IEE 802.3z Base1000SX 802.3x (Ethernet Flow Control) 802.1Q (VLANs) 802.1P (Quality of Service)  FCC B (USA) CE (European Union) ICES-003 B (Canada) BSMI (Taiwan) VCCI (Japan) KCC (Korea) CTICK (Australia/New Zealand)  UL (Safety) RoHS (Restricted or Hazardous Substances)
<b>Power Requirement</b>	2W (Typical)
<b>Operating Temperature</b>	32° to 122° F (0° to 50° C)
<b>Physical Dimensions (LxW)</b>	LC Fiber Board: 37mm x 45mm x 13mm (WxLxH, including connector) Cable: 200mm M.2 Board: 22mm x 30mm x 1.75mm (WxLxH)
<b>Kit Contents</b>	LC fiber board, M.2 board, connecting cable, and 2 screws for attaching the LC fiber board to the motherboard Product Warranty statement and the Installation Guide.

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### Technical Specifications – Miscellaneous Features

#### MISCELLANEOUS FEATURES

##### Management Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel® Wired for Management support; industry wide initiative to make Intel® architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

##### Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
  - Power LED will blink red 2 to 5 times, then blink white 2 or more times, then repeat (with beep tones for each blink initially):
    - 2 red + 2 white User must provide file for BIOS recovery (USB storage typically) + 2 white User must provide file for BIOS recovery (USB storage typically) + 2 white User must provide file for BIOS recovery (USB storage typically)
    - 2 red + 3 white User must enter a key sequence to proceed with recovery by policy + 3 white User must enter a key sequence to proceed with recovery by policy + 3 white User must enter a key sequence to proceed with recovery by policy
    - 2 red + 4 white BIOS recovery is in progress + 4 white BIOS recovery is in progress + 4 white BIOS recovery is in progress
    - 3 red + 2 white Memory could not be initialized + 2 white Memory could not be initialized + 2 white Memory could not be initialized
    - 3 red + 3 white Graphics adaptor could not be found + 3 white Graphics adaptor could not be found + 3 white Graphics adaptor could not be found
    - 3 red + 4 white Power supply failure / not connected + 4 white Power supply failure / not connected + 4 white Power supply failure / not connected
    - 3 red + 5 white Processor not installed + 5 white Processor not installed + 5 white Processor not installed
    - 3 red + 6 white Current processor does not support an enabled feature + 6 white Current processor does not support an enabled feature + 6 white Current processor does not support an enabled feature
    - 4 red + 2 white Processor has exceeded its temperature threshold / system thermal shutdown + 2 white Processor has exceeded its temperature threshold / system thermal shutdown + 2 white Processor has exceeded its temperature threshold / system thermal shutdown
    - 4 red + 3 white System internal temperature has exceeded its threshold + 3 white System internal temperature has exceeded its threshold + 3 white System internal temperature has exceeded its threshold
    - 5 red + 2 white System controller firmware is not valid
    - 5 red + 3 white System controller detected BIOS is not executing
    - 5 red + 4 white BIOS could not complete initialization / PCA failure
    - 5 red + 5 white System controller rebooted the system after a health or recovery timer triggered rebooted the system after a health or recovery timer triggered rebooted the system after a health or recovery timer triggered
- HP PC Hardware Diagnostics UEFI:
  - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software
- Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)

## Technical Specifications – Miscellaneous Features

- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy Identification

### Summary of Changes

<b>Date of change:</b>	<b>Version History:</b>		<b>Description of change:</b>
September 9, 2020	From v1 to v2	<b>Changed</b>	Format
December 18, 2020	From v2 to v3	<b>Changed</b>	Processors, Other Hardware, HP Bios, Storage / Hard Drives, Networking and Communications, and Input Devices sections
February 1, 2021	From v3 to v4	<b>Changed</b>	Operating Systems, Storage / Hard Drives and NETWORKING AND COMMUNICATIONS sections
March 1, 2021	From v4 to v5	<b>Changed</b>	Social and Environmental Responsibility section
April 13, 2021	From v5 to v6	<b>Changed</b>	Format page 2 and changed Graphics section
April 19, 2021	From v6 to v7	<b>Added</b>	DisplayPort matrix page 2
May 1, 2021	From v7 to v8	<b>Added</b>	Service, Support, and Warranty section
May 26, 2021	From v8 to v9	<b>Changed</b>	Nvidia Quadro RTX 3000 6GB Graphics section
May 31, 2021	From v9 to v10	<b>Added</b>	HP Smart Support and footnote
June 30, 2021	From v10 to v11	<b>Changed</b>	Format page 2, 6 and 11
August 1, 2021	From v11 to v12	<b>Changed</b>	Other Hardware section
September 1, 2021	From v12 to v13	<b>Changed</b>	Input Devices, Graphics and Racking and Physical Security sections
September 30, 2021	From v13 to v14	<b>Added</b>	HP Z2 G5 Mini, bottom view section
December 1, 2021	From v14 to v15	<b>Changed</b>	Operating Systems, Graphics, Storage / Hard Drives, Racking and Physical Security and Input Devices sections
December 3, 2021	From v15 to v16	<b>Changed</b>	SOFTWARE AND SECURITY section
December 15, 2021	From v16 to v17	<b>Changed</b>	OPERATING SYSTEM and Social and Environmental Responsibility sections
January 1, 2022	From v17 to v18	<b>Changed</b>	OPERATING SYSTEM and Application Software sections
February 2, 2022	From v18 to v19	<b>Changed</b>	Storage / Hard Drives section

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